

RoHS3 Certificate of Compliance

This is to certify that all the parts listed in Annex-1 below are RoHS3 compliant and meet the requirements of the current EU RoHS Directive 2015/863/EU.

Substance	Maximum Control Value
Lead	0.1% by weight (1000 ppm)
Mercury	0.1% by weight (1000 ppm)
Cadmium	0.01% by weight (100 ppm)
Hexavalent Chromium	0.1% by weight (1000 ppm)
Polybrominated Biphenyls (PBB)	0.1% by weight (1000 ppm)
Polybrominated Diphenyl Ethers (PBDE)	0.1% by weight (1000 ppm)
DBP	0.1% by weight (1000 ppm)
BBP	0.1% by weight (1000 ppm)
DEHP	0.1% by weight (1000 ppm)
DIBP	0.1% by weight (1000 ppm)

Product Name: Inductor

Authorized signatory

Signature: Pambo Cno

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Annex-1

ROHS3 Compliance by Part Number

Part Number	Description	RoHS Compliant	Exemptions
RT SERIES	Thin Film Chip Inductor	Pass	None
RT-M SERIES	Thin Film Chip Inductor	Pass	None
SM-S SERIES	Multilayer Chip Inductor	Pass	None
SM-F SERIES	Multilayer Chip Inductor	Pass	None
XM SERIES	Wire Wound Chip Inductor	Pass	None
XMM SERIES	Wire Wound Chip Inductor	Pass	None
LKI SERIES	Multilayer Chip Bead	Pass	None
LKM SERIES	Multilayer Chip Bead	Pass	None
SPO SERIES	Non-shielded, Low Profile Wire Wound Power Inductor	Pass	None
SPM SERIES	Shielded, Wire Wound Power Inductor	Pass	None
FCG-SERIES	Non-shielded, High Power, Wire Wound Power Inductor	Pass	None
FCH-SERIES	Non-shielded, High Power, Wire Wound Power Inductor	Pass	None
LWG-SERIES	Wound Chip Inductors (Ferrite)	Pass	None
FCP SERIES	Wire Wound Type Power Inductor	Pass	None
XLPS SERIES	Thin Film Chip Inductor	Pass	None
LMG SERIES	Non-shielded, High Power, Wire Wound Power Inductor	Pass	None
XLPF SERIES	Shielded SMD Power Inductor	Pass	None